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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

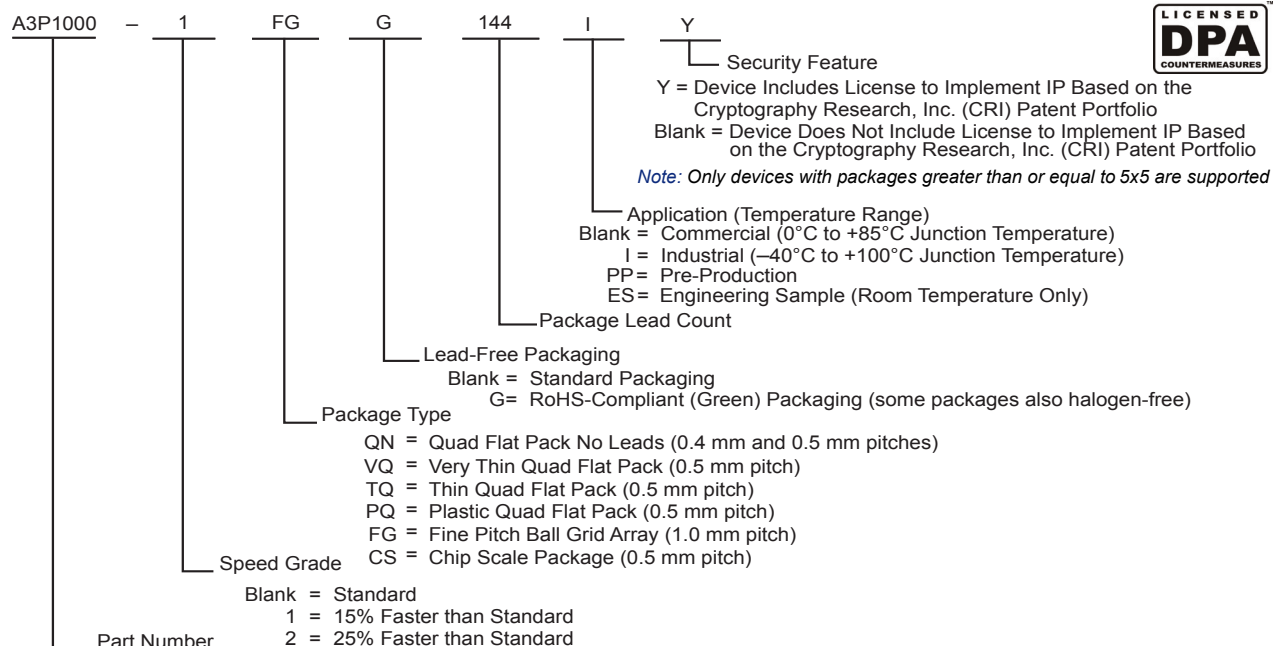
### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |                                                                                                                                                                     |
|--------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Active                                                                                                                                                              |
| Number of LABs/CLBs            | -                                                                                                                                                                   |
| Number of Logic Elements/Cells | -                                                                                                                                                                   |
| Total RAM Bits                 | 36864                                                                                                                                                               |
| Number of I/O                  | 97                                                                                                                                                                  |
| Number of Gates                | 250000                                                                                                                                                              |
| Voltage - Supply               | 1.425V ~ 1.575V                                                                                                                                                     |
| Mounting Type                  | Surface Mount                                                                                                                                                       |
| Operating Temperature          | -40°C ~ 100°C (TJ)                                                                                                                                                  |
| Package / Case                 | 144-LBGA                                                                                                                                                            |
| Supplier Device Package        | 144-FPBGA (13x13)                                                                                                                                                   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/microchip-technology/m1a3p250-fgg144i">https://www.e-xfl.com/product-detail/microchip-technology/m1a3p250-fgg144i</a> |

## ProASIC3 Ordering Information



### ProASIC3 Devices

A3P015 = 15,000 System Gates (A3P015 is not recommended for new designs.)  
 A3P030 = 30,000 System Gates  
 A3P060 = 60,000 System Gates  
 A3P125 = 125,000 System Gates  
 A3P250 = 250,000 System Gates  
 A3P400 = 400,000 System Gates  
 A3P600 = 600,000 System Gates  
 A3P1000 = 1,000,000 System Gates

### ProASIC3 Devices with Cortex-M1

M1A3P250 = 250,000 System Gates  
 M1A3P400 = 400,000 System Gates  
 M1A3P600 = 600,000 System Gates  
 M1A3P1000 = 1,000,000 System Gates

## ProASIC3 Device Status

| ProASIC3 Devices | Status                           | Cortex-M1 Devices | Status     |
|------------------|----------------------------------|-------------------|------------|
| A3P015           | Not recommended for new designs. |                   |            |
| A3P030           | Production                       |                   |            |
| A3P060           | Production                       |                   |            |
| A3P125           | Production                       |                   |            |
| A3P250           | Production                       | M1A3P250          | Production |
| A3P400           | Production                       | M1A3P400          | Production |
| A3P600           | Production                       | M1A3P600          | Production |
| A3P1000          | Production                       | M1A3P1000         | Production |

## ProASIC3 Device Family Overview

|                           |     |
|---------------------------|-----|
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## ProASIC3 DC and Switching Characteristics

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## Pin Descriptions

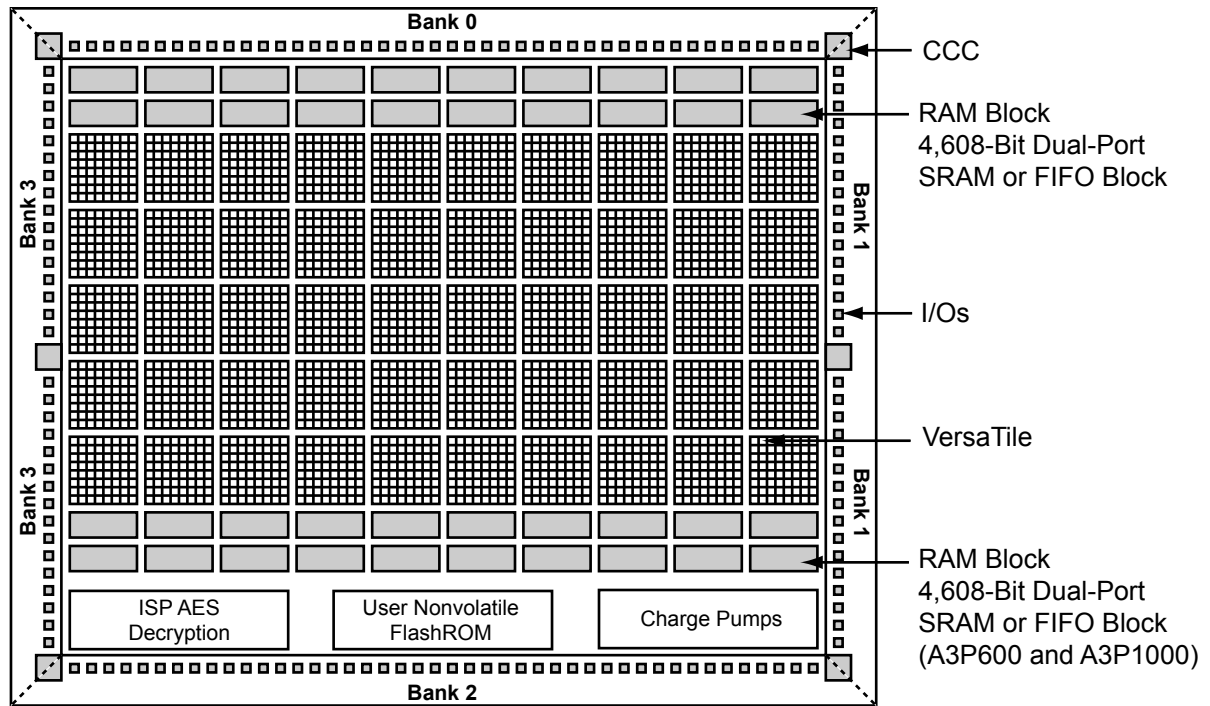
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**Figure 1-2 • ProASIC3 Device Architecture Overview with Four I/O Banks (A3P250, A3P600, and A3P1000)**

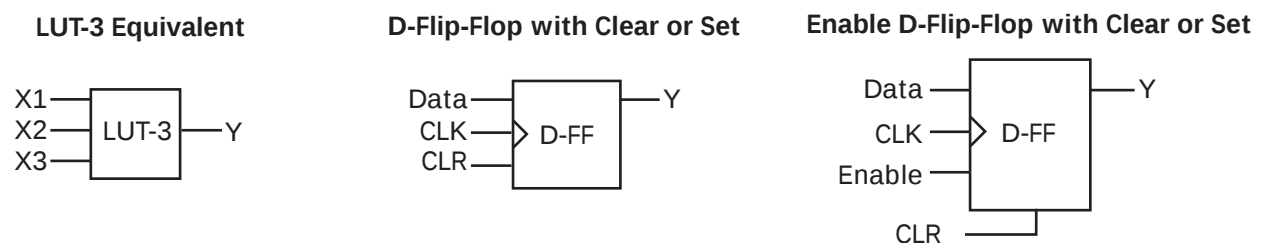
The FPGA core consists of a sea of VersaTiles. Each VersaTile can be configured as a three-input logic function, a D-flip-flop (with or without enable), or a latch by programming the appropriate flash switch interconnections. The versatility of the ProASIC3 core tile as either a three-input lookup table (LUT) equivalent or as a D-flip-flop/latch with enable allows for efficient use of the FPGA fabric. The VersaTile capability is unique to the Microsemi ProASIC family of third-generation architecture flash FPGAs. VersaTiles are connected with any of the four levels of routing hierarchy. Flash switches are distributed throughout the device to provide nonvolatile, reconfigurable interconnect programming. Maximum core utilization is possible for virtually any design.

### VersaTiles

The ProASIC3 core consists of VersaTiles, which have been enhanced beyond the ProASIC<sup>PLUS</sup>® core tiles. The ProASIC3 VersaTile supports the following:

- All 3-input logic functions—LUT-3 equivalent
- Latch with clear or set
- D-flip-flop with clear or set
- Enable D-flip-flop with clear or set

Refer to [Figure 1-3](#) for VersaTile configurations.



**Figure 1-3 • VersaTile Configurations**

The absolute maximum junction temperature is 100°C. EQ 1 shows a sample calculation of the absolute maximum power dissipation allowed for a 484-pin FBGA package at commercial temperature and in still air.

$$\text{Maximum Power Allowed} = \frac{\text{Max. junction temp. (°C)} - \text{Max. ambient temp. (°C)}}{\theta_{ja} (\text{°C/W})} = \frac{100^{\circ}\text{C} - 70^{\circ}\text{C}}{20.5^{\circ}\text{C/W}} = 1.463 \text{ W}$$

EQ 1

**Table 2-5 • Package Thermal Resistivities**

| Package Type                      | Device      | Pin Count | $\theta_{jc}$ | $\theta_{ja}$ |            |            | Units |
|-----------------------------------|-------------|-----------|---------------|---------------|------------|------------|-------|
|                                   |             |           |               | Still Air     | 200 ft/min | 500 ft/min |       |
| Quad Flat No Lead                 | A3P030      | 132       | 0.4           | 21.4          | 16.8       | 15.3       | °C/W  |
|                                   | A3P060      | 132       | 0.3           | 21.2          | 16.6       | 15.0       | °C/W  |
|                                   | A3P125      | 132       | 0.2           | 21.1          | 16.5       | 14.9       | °C/W  |
|                                   | A3P250      | 132       | 0.1           | 21.0          | 16.4       | 14.8       | °C/W  |
| Very Thin Quad Flat Pack (VQFP)   | All devices | 100       | 10.0          | 35.3          | 29.4       | 27.1       | °C/W  |
| Thin Quad Flat Pack (TQFP)        | All devices | 144       | 11.0          | 33.5          | 28.0       | 25.7       | °C/W  |
| Plastic Quad Flat Pack (PQFP)     | All devices | 208       | 8.0           | 26.1          | 22.5       | 20.8       | °C/W  |
| Fine Pitch Ball Grid Array (FBGA) | See note*   | 144       | 3.8           | 26.9          | 22.9       | 21.5       | °C/W  |
|                                   | See note*   | 256       | 3.8           | 26.6          | 22.8       | 21.5       | °C/W  |
|                                   | See note*   | 484       | 3.2           | 20.5          | 17.0       | 15.9       | °C/W  |
|                                   | A3P1000     | 144       | 6.3           | 31.6          | 26.2       | 24.2       | °C/W  |
|                                   | A3P1000     | 256       | 6.6           | 28.1          | 24.4       | 22.7       | °C/W  |
|                                   | A3P1000     | 484       | 8.0           | 23.3          | 19.0       | 16.7       | °C/W  |

**Note:** \*This information applies to all ProASIC3 devices except the A3P1000. Detailed device/package thermal information will be available in future revisions of the datasheet.

## Temperature and Voltage Derating Factors

**Table 2-6 • Temperature and Voltage Derating Factors for Timing Delays**  
 (normalized to  $T_J = 70^{\circ}\text{C}$ ,  $V_{CC} = 1.425 \text{ V}$ )

| Array Voltage VCC (V) | Junction Temperature (°C) |      |      |      |      |       |
|-----------------------|---------------------------|------|------|------|------|-------|
|                       | –40°C                     | 0°C  | 25°C | 70°C | 85°C | 100°C |
| 1.425                 | 0.88                      | 0.93 | 0.95 | 1.00 | 1.02 | 1.04  |
| 1.500                 | 0.83                      | 0.88 | 0.90 | 0.95 | 0.96 | 0.98  |
| 1.575                 | 0.80                      | 0.84 | 0.87 | 0.91 | 0.93 | 0.94  |

**Table 2-15 • Different Components Contributing to the Static Power Consumption in ProASIC3 Devices**

| Parameter | Definition                                       | Device Specific Static Power (mW)                           |        |        |        |        |        |        |        |
|-----------|--------------------------------------------------|-------------------------------------------------------------|--------|--------|--------|--------|--------|--------|--------|
|           |                                                  | A3P1000                                                     | A3P600 | A3P400 | A3P250 | A3P125 | A3P060 | A3P030 | A3P015 |
| PDC1      | Array static power in Active mode                | See Table 2-7 on page 2-7.                                  |        |        |        |        |        |        |        |
| PDC2      | I/O input pin static power (standard-dependent)  | See Table 2-8 on page 2-7 through Table 2-10 on page 2-8.   |        |        |        |        |        |        |        |
| PDC3      | I/O output pin static power (standard-dependent) | See Table 2-11 on page 2-9 through Table 2-13 on page 2-10. |        |        |        |        |        |        |        |
| PDC4      | Static PLL contribution                          | 2.55 mW                                                     |        |        |        |        |        |        |        |
| PDC5      | Bank quiescent power (VCCI-dependent)            | See Table 2-7 on page 2-7.                                  |        |        |        |        |        |        |        |

**Note:** \*For a different output load, drive strength, or slew rate, Microsemi recommends using the Microsemi Power spreadsheet calculator or SmartPower tool in Libero SoC software.

## Power Calculation Methodology

This section describes a simplified method to estimate power consumption of an application. For more accurate and detailed power estimations, use the SmartPower tool in Libero SoC software.

The power calculation methodology described below uses the following variables:

- The number of PLLs as well as the number and the frequency of each output clock generated
- The number of combinatorial and sequential cells used in the design
- The internal clock frequencies
- The number and the standard of I/O pins used in the design
- The number of RAM blocks used in the design
- Toggle rates of I/O pins as well as VersaTiles—guidelines are provided in Table 2-16 on page 2-14.
- Enable rates of output buffers—guidelines are provided for typical applications in Table 2-17 on page 2-14.
- Read rate and write rate to the memory—guidelines are provided for typical applications in Table 2-17 on page 2-14. The calculation should be repeated for each clock domain defined in the design.

## Methodology

### Total Power Consumption— $P_{TOTAL}$

$$P_{TOTAL} = P_{STAT} + P_{DYN}$$

$P_{STAT}$  is the total static power consumption.

$P_{DYN}$  is the total dynamic power consumption.

### Total Static Power Consumption— $P_{STAT}$

$$P_{STAT} = P_{DC1} + N_{INPUTS} * P_{DC2} + N_{OUTPUTS} * P_{DC3}$$

$N_{INPUTS}$  is the number of I/O input buffers used in the design.

$N_{OUTPUTS}$  is the number of I/O output buffers used in the design.

### Total Dynamic Power Consumption— $P_{DYN}$

$$P_{DYN} = P_{CLOCK} + P_{S-CELL} + P_{C-CELL} + P_{NET} + P_{INPUTS} + P_{OUTPUTS} + P_{MEMORY} + P_{PLL}$$

### Global Clock Contribution— $P_{CLOCK}$

$$P_{CLOCK} = (P_{AC1} + N_{SPINE} * P_{AC2} + N_{ROW} * P_{AC3} + N_{S-CELL} * P_{AC4}) * F_{CLK}$$

$N_{SPINE}$  is the number of global spines used in the user design—guidelines are provided in the "Spine Architecture" section of the Global Resources chapter in the *ProASIC3 FPGA Fabric User's Guide*.

$N_{ROW}$  is the number of VersaTile rows used in the design—guidelines are provided in the "Spine Architecture" section of the Global Resources chapter in the *ProASIC3 FPGA Fabric User's Guide*.

## I/O DC Characteristics

**Table 2-27 • Input Capacitance**

| Symbol      | Definition                         | Conditions                   | Min | Max | Units |
|-------------|------------------------------------|------------------------------|-----|-----|-------|
| $C_{IN}$    | Input capacitance                  | $V_{IN} = 0$ , $f = 1.0$ MHz | –   | 8   | pF    |
| $C_{INCLK}$ | Input capacitance on the clock pin | $V_{IN} = 0$ , $f = 1.0$ MHz | –   | 8   | pF    |

**Table 2-28 • I/O Output Buffer Maximum Resistances<sup>1</sup>**  
Applicable to Advanced I/O Banks

| Standard                             | Drive Strength              | $R_{PULL-DOWN} (\Omega)^2$   | $R_{PULL-UP} (\Omega)^3$     |
|--------------------------------------|-----------------------------|------------------------------|------------------------------|
| 3.3 V LVTTTL / 3.3 V LVCMOS          | 2 mA                        | 100                          | 300                          |
|                                      | 4 mA                        | 100                          | 300                          |
|                                      | 6 mA                        | 50                           | 150                          |
|                                      | 8 mA                        | 50                           | 150                          |
|                                      | 12 mA                       | 25                           | 75                           |
|                                      | 16 mA                       | 17                           | 50                           |
|                                      | 24 mA                       | 11                           | 33                           |
| 3.3 V LVCMOS Wide Range <sup>4</sup> | 100 $\mu$ A                 | Same as regular 3.3 V LVCMOS | Same as regular 3.3 V LVCMOS |
| 2.5 V LVCMOS                         | 2 mA                        | 100                          | 200                          |
|                                      | 4 mA                        | 100                          | 200                          |
|                                      | 6 mA                        | 50                           | 100                          |
|                                      | 8 mA                        | 50                           | 100                          |
|                                      | 12 mA                       | 25                           | 50                           |
|                                      | 16 mA                       | 20                           | 40                           |
|                                      | 24 mA                       | 11                           | 22                           |
| 1.8 V LVCMOS                         | 2 mA                        | 200                          | 225                          |
|                                      | 4 mA                        | 100                          | 112                          |
|                                      | 6 mA                        | 50                           | 56                           |
|                                      | 8 mA                        | 50                           | 56                           |
|                                      | 12 mA                       | 20                           | 22                           |
|                                      | 16 mA                       | 20                           | 22                           |
| 1.5 V LVCMOS                         | 2 mA                        | 200                          | 224                          |
|                                      | 4 mA                        | 100                          | 112                          |
|                                      | 6 mA                        | 67                           | 75                           |
|                                      | 8 mA                        | 33                           | 37                           |
|                                      | 12 mA                       | 33                           | 37                           |
| 3.3 V PCI/PCI-X                      | Per PCI/PCI-X specification | 25                           | 75                           |

**Notes:**

1. These maximum values are provided for informational reasons only. Minimum output buffer resistance values depend on  $V_{CCI}$ , drive strength selection, temperature, and process. For board design considerations and detailed output buffer resistances, use the corresponding IBIS models located at <http://www.microsemi.com/soc/download/ibis/default.aspx>.
2.  $R_{(PULL-DOWN-MAX)} = (VOL_{spec}) / IOL_{spec}$
3.  $R_{(PULL-UP-MAX)} = (VCCImax - VOH_{spec}) / IOH_{spec}$
4. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD-8B specification.

## Single-Ended I/O Characteristics

### 3.3 V LVTTTL / 3.3 V LVCMOS

Low-Voltage Transistor–Transistor Logic (LVTTTL) is a general-purpose standard (EIA/JESD) for 3.3 V applications. It uses an LVTTTL input buffer and push-pull output buffer.

**Table 2-37 • Minimum and Maximum DC Input and Output Levels**  
Applicable to Advanced I/O Banks

| 3.3 V LVTTTL /<br>3.3 V LVCMOS | VIL      |          | VIH      |          | VOL      | VOH      | IOL | IOH | IOSL                   | IOSH                   | IIL <sup>1</sup> | IIH <sup>2</sup> |
|--------------------------------|----------|----------|----------|----------|----------|----------|-----|-----|------------------------|------------------------|------------------|------------------|
| Drive Strength                 | Min<br>V | Max<br>V | Min<br>V | Max<br>V | Max<br>V | Min<br>V | mA  | mA  | Max<br>mA <sup>3</sup> | Max<br>mA <sup>3</sup> | μA <sup>4</sup>  | μA <sup>4</sup>  |
| 2 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 2   | 2   | 27                     | 25                     | 10               | 10               |
| 4 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 4   | 4   | 27                     | 25                     | 10               | 10               |
| 6 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 6   | 6   | 54                     | 51                     | 10               | 10               |
| 8 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 8   | 8   | 54                     | 51                     | 10               | 10               |
| 12 mA                          | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 12  | 12  | 109                    | 103                    | 10               | 10               |
| 16 mA                          | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 16  | 16  | 127                    | 132                    | 10               | 10               |
| 24 mA                          | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 24  | 24  | 181                    | 268                    | 10               | 10               |

Notes:

1. IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
2. IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges
3. Currents are measured at 100°C junction temperature and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.

**Table 2-38 • Minimum and Maximum DC Input and Output Levels**  
Applicable to Standard Plus I/O Banks

| 3.3 V LVTTTL /<br>3.3 V LVCMOS | VIL      |          | VIH      |          | VOL      | VOH      | IOL | IOH | IOSL                   | IOSH                   | IIL <sup>1</sup> | IIH <sup>2</sup> |
|--------------------------------|----------|----------|----------|----------|----------|----------|-----|-----|------------------------|------------------------|------------------|------------------|
| Drive Strength                 | Min<br>V | Max<br>V | Min<br>V | Max<br>V | Max<br>V | Min<br>V | mA  | mA  | Max<br>mA <sup>3</sup> | Max<br>mA <sup>3</sup> | μA <sup>4</sup>  | μA <sup>4</sup>  |
| 2 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 2   | 2   | 27                     | 25                     | 10               | 10               |
| 4 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 4   | 4   | 27                     | 25                     | 10               | 10               |
| 6 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 6   | 6   | 54                     | 51                     | 10               | 10               |
| 8 mA                           | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 8   | 8   | 54                     | 51                     | 10               | 10               |
| 12 mA                          | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 12  | 12  | 109                    | 103                    | 10               | 10               |
| 16 mA                          | –0.3     | 0.8      | 2        | 3.6      | 0.4      | 2.4      | 16  | 16  | 109                    | 103                    | 10               | 10               |

Notes:

1. IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
2. IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges
3. Currents are measured at 100°C junction temperature and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.

**Table 2-64 • 2.5 V LVCMOS High Slew**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.425\text{ V}$ , Worst-Case  $V_{CCI} = 3.0\text{ V}$   
Applicable to Standard I/O Banks

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|------------|----------|----------|----------|----------|-------|
| 2 mA           | Std.        | 0.66       | 8.20     | 0.04      | 1.29     | 0.43       | 7.24     | 8.20     | 2.03     | 1.91     | ns    |
|                | –1          | 0.56       | 6.98     | 0.04      | 1.10     | 0.36       | 6.16     | 6.98     | 1.73     | 1.62     | ns    |
|                | –2          | 0.49       | 6.13     | 0.03      | 0.96     | 0.32       | 5.41     | 6.13     | 1.52     | 1.43     | ns    |
| 4 mA           | Std.        | 0.66       | 8.20     | 0.04      | 1.29     | 0.43       | 7.24     | 8.20     | 2.03     | 1.91     | ns    |
|                | –1          | 0.56       | 6.98     | 0.04      | 1.10     | 0.36       | 6.16     | 6.98     | 1.73     | 1.62     | ns    |
|                | –2          | 0.49       | 6.13     | 0.03      | 0.96     | 0.32       | 5.41     | 6.13     | 1.52     | 1.43     | ns    |
| 6 mA           | Std.        | 0.66       | 4.77     | 0.04      | 1.29     | 0.43       | 4.55     | 4.77     | 2.38     | 2.55     | ns    |
|                | –1          | 0.56       | 4.05     | 0.04      | 1.10     | 0.36       | 3.87     | 4.05     | 2.03     | 2.17     | ns    |
|                | –2          | 0.49       | 3.56     | 0.03      | 0.96     | 0.32       | 3.40     | 3.56     | 1.78     | 1.91     | ns    |
| 8 mA           | Std.        | 0.66       | 4.77     | 0.04      | 1.29     | 0.43       | 4.55     | 4.77     | 2.38     | 2.55     | ns    |
|                | –1          | 0.56       | 4.05     | 0.04      | 1.10     | 0.36       | 3.87     | 4.05     | 2.03     | 2.17     | ns    |
|                | –2          | 0.49       | 3.56     | 0.03      | 0.96     | 0.32       | 3.40     | 3.56     | 1.78     | 1.91     | ns    |

**Notes:**

1. Software default selection highlighted in gray.
2. For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**Table 2-65 • 2.5 V LVCMOS Low Slew**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.425\text{ V}$ , Worst-Case  $V_{CCI} = 3.0\text{ V}$   
Applicable to Standard I/O Banks

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|------------|----------|----------|----------|----------|-------|
| 2 mA           | Std.        | 0.66       | 11.00    | 0.04      | 1.29     | 0.43       | 10.37    | 11.00    | 2.03     | 1.83     | ns    |
|                | –1          | 0.56       | 9.35     | 0.04      | 1.10     | 0.36       | 8.83     | 9.35     | 1.73     | 1.56     | ns    |
|                | –2          | 0.49       | 8.21     | 0.03      | 0.96     | 0.32       | 7.75     | 8.21     | 1.52     | 1.37     | ns    |
| 4 mA           | Std.        | 0.66       | 11.00    | 0.04      | 1.29     | 0.43       | 10.37    | 11.00    | 2.03     | 1.83     | ns    |
|                | –1          | 0.56       | 9.35     | 0.04      | 1.10     | 0.36       | 8.83     | 9.35     | 1.73     | 1.56     | ns    |
|                | –2          | 0.49       | 8.21     | 0.03      | 0.96     | 0.32       | 7.75     | 8.21     | 1.52     | 1.37     | ns    |
| 6 mA           | Std.        | 0.66       | 7.50     | 0.04      | 1.29     | 0.43       | 7.36     | 7.50     | 2.39     | 2.46     | ns    |
|                | –1          | 0.56       | 6.38     | 0.04      | 1.10     | 0.36       | 6.26     | 6.38     | 2.03     | 2.10     | ns    |
|                | –2          | 0.49       | 5.60     | 0.03      | 0.96     | 0.32       | 5.49     | 5.60     | 1.78     | 1.84     | ns    |
| 8 mA           | Std.        | 0.66       | 7.50     | 0.04      | 1.29     | 0.43       | 7.36     | 7.50     | 2.39     | 2.46     | ns    |
|                | –1          | 0.56       | 6.38     | 0.04      | 1.10     | 0.36       | 6.26     | 6.38     | 2.03     | 2.10     | ns    |
|                | –2          | 0.49       | 5.60     | 0.03      | 0.96     | 0.32       | 5.49     | 5.60     | 1.78     | 1.84     | ns    |

**Note:** For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

## Fully Registered I/O Buffers with Synchronous Enable and Asynchronous Clear

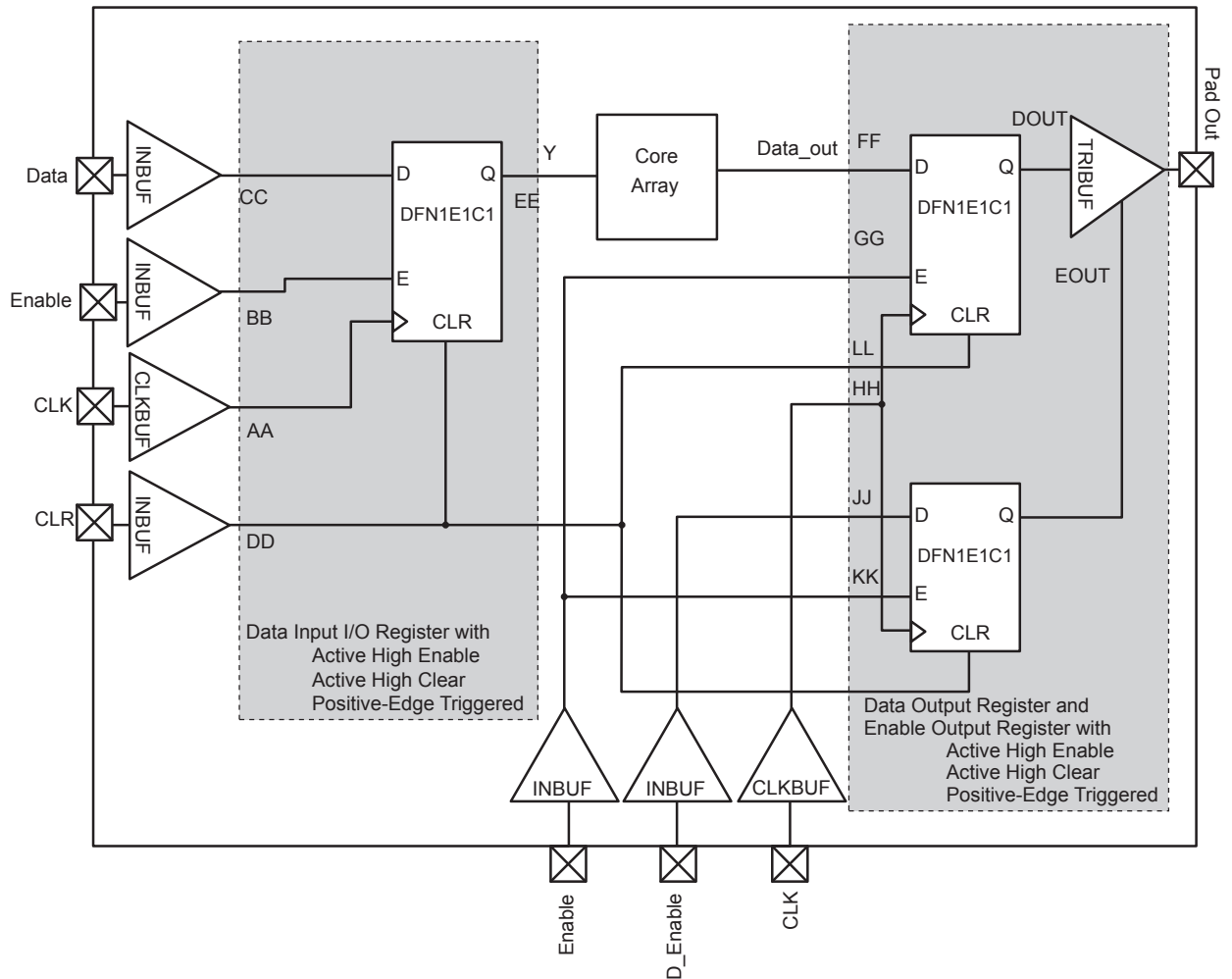
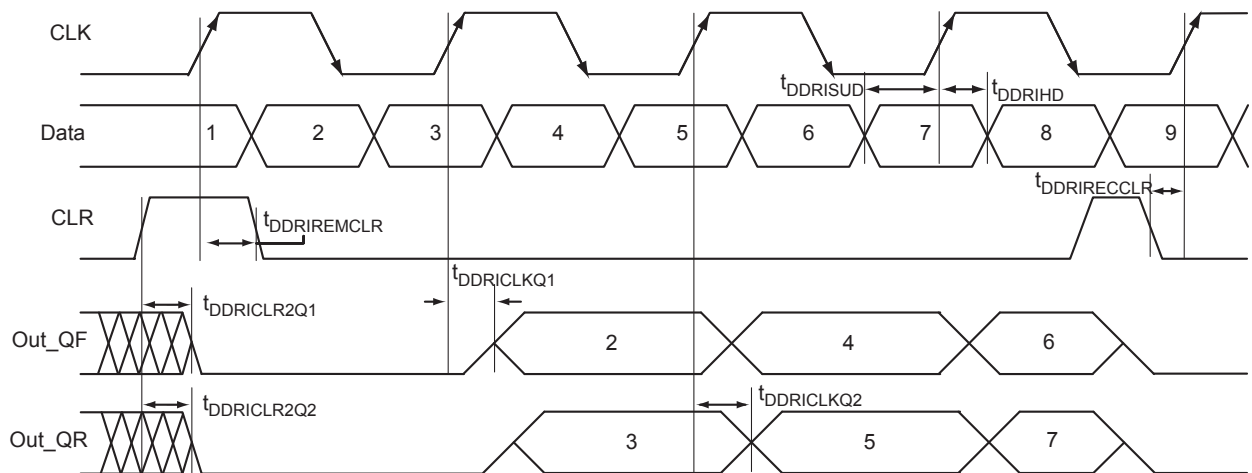


Figure 2-16 • Timing Model of the Registered I/O Buffers with Synchronous Enable and Asynchronous Clear



**Figure 2-21 • Input DDR Timing Diagram**

### Timing Characteristics

**Table 2-102 • Input DDR Propagation Delays**

Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ , Worst Case  $V_{CC} = 1.425\text{ V}$

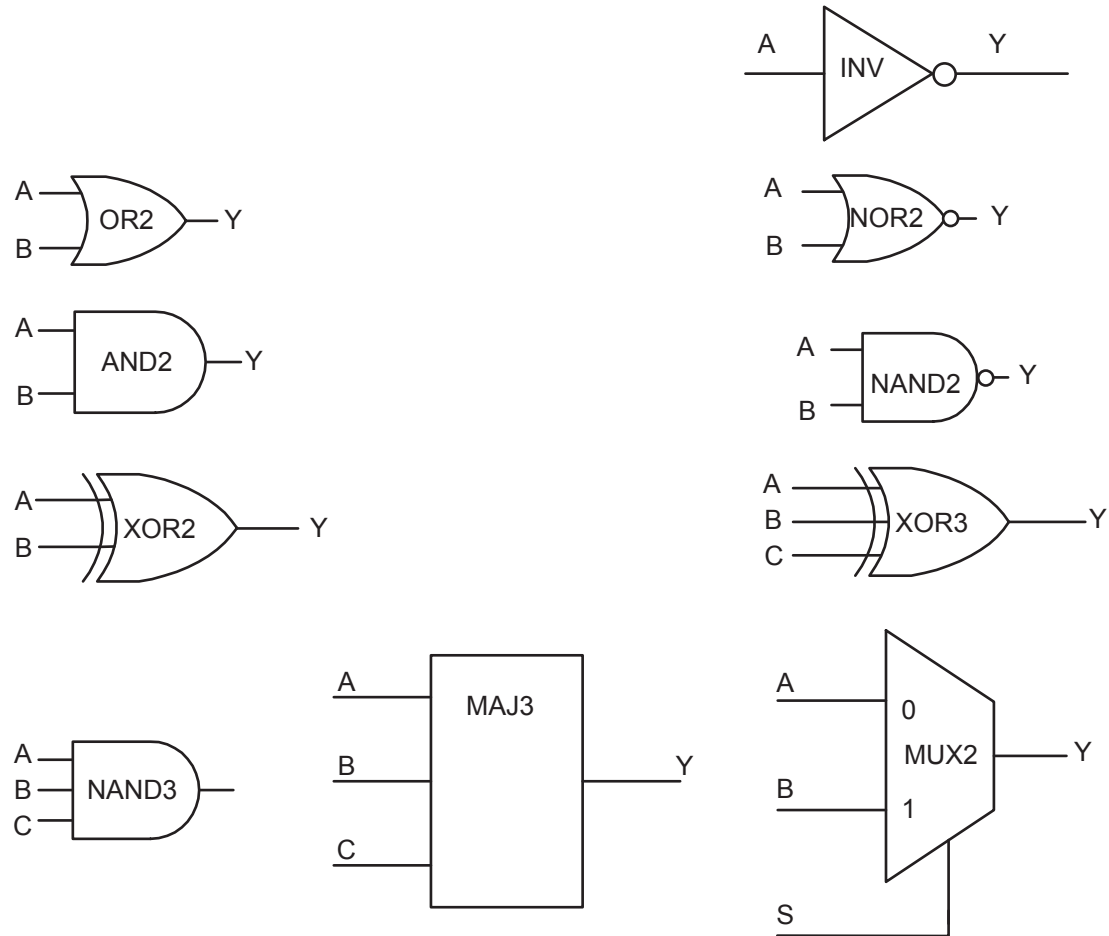
| Parameter                | Description                                          | -2   | -1   | Std. | Units |
|--------------------------|------------------------------------------------------|------|------|------|-------|
| $t_{\text{DDRICKQ1}}$    | Clock-to-Out Out_QR for Input DDR                    | 0.27 | 0.31 | 0.37 | ns    |
| $t_{\text{DDRICKQ2}}$    | Clock-to-Out Out_QF for Input DDR                    | 0.39 | 0.44 | 0.52 | ns    |
| $t_{\text{DDRISUD}}$     | Data Setup for Input DDR (Fall)                      | 0.25 | 0.28 | 0.33 | ns    |
|                          | Data Setup for Input DDR (Rise)                      | 0.25 | 0.28 | 0.33 | ns    |
| $t_{\text{DDRIMHD}}$     | Data Hold for Input DDR (Fall)                       | 0.00 | 0.00 | 0.00 | ns    |
|                          | Data Hold for Input DDR (Rise)                       | 0.00 | 0.00 | 0.00 | ns    |
| $t_{\text{DDRIMCLR2Q1}}$ | Asynchronous Clear-to-Out Out_QR for Input DDR       | 0.46 | 0.53 | 0.62 | ns    |
| $t_{\text{DDRIMCLR2Q2}}$ | Asynchronous Clear-to-Out Out_QF for Input DDR       | 0.57 | 0.65 | 0.76 | ns    |
| $t_{\text{DDRIMCLR}}$    | Asynchronous Clear Removal time for Input DDR        | 0.00 | 0.00 | 0.00 | ns    |
| $t_{\text{DDRIMCLR}}$    | Asynchronous Clear Recovery time for Input DDR       | 0.22 | 0.25 | 0.30 | ns    |
| $t_{\text{DDRIMCLR}}$    | Asynchronous Clear Minimum Pulse Width for Input DDR | 0.22 | 0.25 | 0.30 | ns    |
| $t_{\text{DDRICKMPWH}}$  | Clock Minimum Pulse Width High for Input DDR         | 0.36 | 0.41 | 0.48 | ns    |
| $t_{\text{DDRICKMPWL}}$  | Clock Minimum Pulse Width Low for Input DDR          | 0.32 | 0.37 | 0.43 | ns    |
| $F_{\text{DDRIMAX}}$     | Maximum Frequency for Input DDR                      | 350  | 309  | 263  | MHz   |

**Note:** For specific junction temperature and voltage-supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

## VersaTile Characteristics

### VersaTile Specifications as a Combinatorial Module

The ProASIC3 library offers all combinations of LUT-3 combinatorial functions. In this section, timing characteristics are presented for a sample of the library. For more details, refer to the [Fusion](#), [IGLOO®/e](#), and [ProASIC3/E Macro Library Guide](#).



**Figure 2-24 • Sample of Combinatorial Cells**

**Table 2-120 • A3P250 FIFO 512×8**
**Worst Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ ,  $V_{CC} = 1.425\text{ V}$** 

| Parameter            | Description                                       | –2   | –1   | Std. | Units |
|----------------------|---------------------------------------------------|------|------|------|-------|
| $t_{\text{ENS}}$     | REN, WEN Setup Time                               | 3.75 | 4.27 | 5.02 | ns    |
| $t_{\text{ENH}}$     | REN, WEN Hold Time                                | 0.00 | 0.00 | 0.00 | ns    |
| $t_{\text{BKS}}$     | BLK Setup Time                                    | 0.19 | 0.22 | 0.26 | ns    |
| $t_{\text{BKH}}$     | BLK Hold Time                                     | 0.00 | 0.00 | 0.00 | ns    |
| $t_{\text{DS}}$      | Input Data (WD) Setup Time                        | 0.18 | 0.21 | 0.25 | ns    |
| $t_{\text{DH}}$      | Input Data (WD) Hold Time                         | 0.00 | 0.00 | 0.00 | ns    |
| $t_{\text{CKQ1}}$    | Clock High to New Data Valid on RD (flow-through) | 2.17 | 2.47 | 2.90 | ns    |
| $t_{\text{CKQ2}}$    | Clock High to New Data Valid on RD (pipelined)    | 0.94 | 1.07 | 1.26 | ns    |
| $t_{\text{RCKEF}}$   | RCLK High to Empty Flag Valid                     | 1.72 | 1.96 | 2.30 | ns    |
| $t_{\text{WCKFF}}$   | WCLK High to Full Flag Valid                      | 1.63 | 1.86 | 2.18 | ns    |
| $t_{\text{CKAF}}$    | Clock High to Almost Empty/Full Flag Valid        | 6.19 | 7.05 | 8.29 | ns    |
| $t_{\text{RSTFG}}$   | RESET Low to Empty/Full Flag Valid                | 1.69 | 1.93 | 2.27 | ns    |
| $t_{\text{RSTAF}}$   | RESET Low to Almost Empty/Full Flag Valid         | 6.13 | 6.98 | 8.20 | ns    |
| $t_{\text{RSTBQ}}$   | RESET Low to Data Out Low on RD (flow-through)    | 0.92 | 1.05 | 1.23 | ns    |
|                      | RESET Low to Data Out Low on RD (pipelined)       | 0.92 | 1.05 | 1.23 | ns    |
| $t_{\text{REMRSTB}}$ | RESET Removal                                     | 0.29 | 0.33 | 0.38 | ns    |
| $t_{\text{RECRSTB}}$ | RESET Recovery                                    | 1.50 | 1.71 | 2.01 | ns    |
| $t_{\text{MPWRSTB}}$ | RESET Minimum Pulse Width                         | 0.21 | 0.24 | 0.29 | ns    |
| $t_{\text{CYC}}$     | Clock Cycle Time                                  | 3.23 | 3.68 | 4.32 | ns    |
| $F_{\text{MAX}}$     | Maximum Frequency for FIFO                        | 310  | 272  | 231  | MHz   |

In critical applications, an upset in the JTAG circuit could allow entrance to an undesired JTAG state. In such cases, Microsemi recommends tying off TRST to GND through a resistor placed close to the FPGA pin.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements.

## Special Function Pins

### **NC**                      **No Connect**

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

### **DC**                      **Do Not Connect**

This pin should not be connected to any signals on the PCB. These pins should be left unconnected.

## Related Documents

### User's Guides

*ProASIC FPGA Fabric User's Guide*

[http://www.microsemi.com/soc/documents/PA3\\_UG.pdf](http://www.microsemi.com/soc/documents/PA3_UG.pdf)

### Packaging

The following documents provide packaging information and device selection for low power flash devices.

#### **Product Catalog**

[http://www.microsemi.com/soc/documents/ProdCat\\_PIB.pdf](http://www.microsemi.com/soc/documents/ProdCat_PIB.pdf)

Lists devices currently recommended for new designs and the packages available for each member of the family. Use this document or the datasheet tables to determine the best package for your design, and which package drawing to use.

#### **Package Mechanical Drawings**

<http://www.microsemi.com/soc/documents/PckgMechDrwns.pdf>

This document contains the package mechanical drawings for all packages currently or previously supplied by Actel. Use the bookmarks to navigate to the package mechanical drawings.

Additional packaging materials are at <http://www.microsemi.com/products/solutions/package/docs.aspx>.

| <b>QN132</b>      |                        |
|-------------------|------------------------|
| <b>Pin Number</b> | <b>A3P060 Function</b> |
| C17               | IO57RSB1               |
| C18               | NC                     |
| C19               | TCK                    |
| C20               | VMV1                   |
| C21               | VPUMP                  |
| C22               | VJTAG                  |
| C23               | VCCIB0                 |
| C24               | NC                     |
| C25               | NC                     |
| C26               | GCA1/IO42RSB0          |
| C27               | GCC0/IO39RSB0          |
| C28               | VCCIB0                 |
| C29               | IO29RSB0               |
| C30               | GNDQ                   |
| C31               | GBA1/IO27RSB0          |
| C32               | GBB0/IO24RSB0          |
| C33               | VCC                    |
| C34               | IO19RSB0               |
| C35               | IO16RSB0               |
| C36               | IO13RSB0               |
| C37               | GAC1/IO10RSB0          |
| C38               | NC                     |
| C39               | GAA0/IO05RSB0          |
| C40               | VMV0                   |
| D1                | GND                    |
| D2                | GND                    |
| D3                | GND                    |
| D4                | GND                    |

| <b>FG144</b>      |                        |
|-------------------|------------------------|
| <b>Pin Number</b> | <b>A3P125 Function</b> |
| K1                | GEB0/IO109RSB1         |
| K2                | GEA1/IO108RSB1         |
| K3                | GEA0/IO107RSB1         |
| K4                | GEA2/IO106RSB1         |
| K5                | IO100RSB1              |
| K6                | IO98RSB1               |
| K7                | GND                    |
| K8                | IO73RSB1               |
| K9                | GDC2/IO72RSB1          |
| K10               | GND                    |
| K11               | GDA0/IO66RSB0          |
| K12               | GDB0/IO64RSB0          |
| L1                | GND                    |
| L2                | VMV1                   |
| L3                | GEB2/IO105RSB1         |
| L4                | IO102RSB1              |
| L5                | VCCIB1                 |
| L6                | IO95RSB1               |
| L7                | IO85RSB1               |
| L8                | IO74RSB1               |
| L9                | TMS                    |
| L10               | VJTAG                  |
| L11               | VMV1                   |
| L12               | TRST                   |
| M1                | GNDQ                   |
| M2                | GEC2/IO104RSB1         |
| M3                | IO103RSB1              |
| M4                | IO101RSB1              |
| M5                | IO97RSB1               |
| M6                | IO94RSB1               |
| M7                | IO86RSB1               |
| M8                | IO75RSB1               |
| M9                | TDI                    |
| M10               | VCCIB1                 |
| M11               | VPUMP                  |
| M12               | GNDQ                   |

| FG144      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| A1         | GNDQ            |
| A2         | VMV0            |
| A3         | GAB0/IO02RSB0   |
| A4         | GAB1/IO03RSB0   |
| A5         | IO16RSB0        |
| A6         | GND             |
| A7         | IO30RSB0        |
| A8         | VCC             |
| A9         | IO34RSB0        |
| A10        | GBA0/IO58RSB0   |
| A11        | GBA1/IO59RSB0   |
| A12        | GNDQ            |
| B1         | GAB2/IO154UDB3  |
| B2         | GND             |
| B3         | GAA0/IO00RSB0   |
| B4         | GAA1/IO01RSB0   |
| B5         | IO14RSB0        |
| B6         | IO19RSB0        |
| B7         | IO23RSB0        |
| B8         | IO31RSB0        |
| B9         | GBB0/IO56RSB0   |
| B10        | GBB1/IO57RSB0   |
| B11        | GND             |
| B12        | VMV1            |
| C1         | IO154VDB3       |
| C2         | GFA2/IO144PPB3  |
| C3         | GAC2/IO153UDB3  |
| C4         | VCC             |
| C5         | IO12RSB0        |
| C6         | IO17RSB0        |
| C7         | IO25RSB0        |
| C8         | IO32RSB0        |
| C9         | IO53RSB0        |
| C10        | GBA2/IO60PDB1   |
| C11        | IO60NDB1        |
| C12        | GBC2/IO62PPB1   |

| FG144      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| D1         | IO149NDB3       |
| D2         | IO149PDB3       |
| D3         | IO153VDB3       |
| D4         | GAA2/IO155UPB3  |
| D5         | GAC0/IO04RSB0   |
| D6         | GAC1/IO05RSB0   |
| D7         | GBC0/IO54RSB0   |
| D8         | GBC1/IO55RSB0   |
| D9         | GBB2/IO61PDB1   |
| D10        | IO61NDB1        |
| D11        | IO62NPB1        |
| D12        | GCB1/IO68PPB1   |
| E1         | VCC             |
| E2         | GFC0/IO147NDB3  |
| E3         | GFC1/IO147PDB3  |
| E4         | VCCIB3          |
| E5         | IO155VPB3       |
| E6         | VCCIB0          |
| E7         | VCCIB0          |
| E8         | GCC1/IO67PDB1   |
| E9         | VCCIB1          |
| E10        | VCC             |
| E11        | GCA0/IO69NDB1   |
| E12        | IO70NDB1        |
| F1         | GFB0/IO146NPB3  |
| F2         | VCOMPLF         |
| F3         | GFB1/IO146PPB3  |
| F4         | IO144NPB3       |
| F5         | GND             |
| F6         | GND             |
| F7         | GND             |
| F8         | GCC0/IO67NDB1   |
| F9         | GCB0/IO68NPB1   |
| F10        | GND             |
| F11        | GCA1/IO69PDB1   |
| F12        | GCA2/IO70PDB1   |

| FG144      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| G1         | GFA1/IO145PPB3  |
| G2         | GND             |
| G3         | VCCPLF          |
| G4         | GFA0/IO145NPB3  |
| G5         | GND             |
| G6         | GND             |
| G7         | GND             |
| G8         | GDC1/IO77UPB1   |
| G9         | IO72NDB1        |
| G10        | GCC2/IO72PDB1   |
| G11        | IO71NDB1        |
| G12        | GCB2/IO71PDB1   |
| H1         | VCC             |
| H2         | GFB2/IO143PDB3  |
| H3         | GFC2/IO142PSB3  |
| H4         | GEC1/IO137PDB3  |
| H5         | VCC             |
| H6         | IO75PDB1        |
| H7         | IO75NDB1        |
| H8         | GDB2/IO81RSB2   |
| H9         | GDC0/IO77VPB1   |
| H10        | VCCIB1          |
| H11        | IO73PSB1        |
| H12        | VCC             |
| J1         | GEB1/IO136PDB3  |
| J2         | IO143NDB3       |
| J3         | VCCIB3          |
| J4         | GEC0/IO137NDB3  |
| J5         | IO125RSB2       |
| J6         | IO116RSB2       |
| J7         | VCC             |
| J8         | TCK             |
| J9         | GDA2/IO80RSB2   |
| J10        | TDO             |
| J11        | GDA1/IO79UDB1   |
| J12        | GDB1/IO78UDB1   |

| FG256      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| A1         | GND             |
| A2         | GAA0/IO00RSB0   |
| A3         | GAA1/IO01RSB0   |
| A4         | GAB0/IO02RSB0   |
| A5         | IO16RSB0        |
| A6         | IO17RSB0        |
| A7         | IO22RSB0        |
| A8         | IO28RSB0        |
| A9         | IO34RSB0        |
| A10        | IO37RSB0        |
| A11        | IO41RSB0        |
| A12        | IO43RSB0        |
| A13        | GBB1/IO57RSB0   |
| A14        | GBA0/IO58RSB0   |
| A15        | GBA1/IO59RSB0   |
| A16        | GND             |
| B1         | GAB2/IO154UDB3  |
| B2         | GAA2/IO155UDB3  |
| B3         | IO12RSB0        |
| B4         | GAB1/IO03RSB0   |
| B5         | IO13RSB0        |
| B6         | IO14RSB0        |
| B7         | IO21RSB0        |
| B8         | IO27RSB0        |
| B9         | IO32RSB0        |
| B10        | IO38RSB0        |
| B11        | IO42RSB0        |
| B12        | GBC1/IO55RSB0   |
| B13        | GBB0/IO56RSB0   |
| B14        | IO44RSB0        |
| B15        | GBA2/IO60PDB1   |
| B16        | IO60NDB1        |
| C1         | IO154VDB3       |
| C2         | IO155VDB3       |
| C3         | IO11RSB0        |
| C4         | IO07RSB0        |

| FG256      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| C5         | GAC0/IO04RSB0   |
| C6         | GAC1/IO05RSB0   |
| C7         | IO20RSB0        |
| C8         | IO24RSB0        |
| C9         | IO33RSB0        |
| C10        | IO39RSB0        |
| C11        | IO45RSB0        |
| C12        | GBC0/IO54RSB0   |
| C13        | IO48RSB0        |
| C14        | VMV0            |
| C15        | IO61NPB1        |
| C16        | IO63PDB1        |
| D1         | IO151VDB3       |
| D2         | IO151UDB3       |
| D3         | GAC2/IO153UDB3  |
| D4         | IO06RSB0        |
| D5         | GNDQ            |
| D6         | IO10RSB0        |
| D7         | IO19RSB0        |
| D8         | IO26RSB0        |
| D9         | IO30RSB0        |
| D10        | IO40RSB0        |
| D11        | IO46RSB0        |
| D12        | GNDQ            |
| D13        | IO47RSB0        |
| D14        | GBB2/IO61PPB1   |
| D15        | IO53RSB0        |
| D16        | IO63NDB1        |
| E1         | IO150PDB3       |
| E2         | IO08RSB0        |
| E3         | IO153VDB3       |
| E4         | IO152VDB3       |
| E5         | VMV0            |
| E6         | VCCIB0          |
| E7         | VCCIB0          |
| E8         | IO25RSB0        |

| FG256      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| E9         | IO31RSB0        |
| E10        | VCCIB0          |
| E11        | VCCIB0          |
| E12        | VMV1            |
| E13        | GBC2/IO62PDB1   |
| E14        | IO65RSB1        |
| E15        | IO52RSB0        |
| E16        | IO66PDB1        |
| F1         | IO150NDB3       |
| F2         | IO149NPB3       |
| F3         | IO09RSB0        |
| F4         | IO152UDB3       |
| F5         | VCCIB3          |
| F6         | GND             |
| F7         | VCC             |
| F8         | VCC             |
| F9         | VCC             |
| F10        | VCC             |
| F11        | GND             |
| F12        | VCCIB1          |
| F13        | IO62NDB1        |
| F14        | IO49RSB0        |
| F15        | IO64PPB1        |
| F16        | IO66NDB1        |
| G1         | IO148NDB3       |
| G2         | IO148PDB3       |
| G3         | IO149PPB3       |
| G4         | GFC1/IO147PPB3  |
| G5         | VCCIB3          |
| G6         | VCC             |
| G7         | GND             |
| G8         | GND             |
| G9         | GND             |
| G10        | GND             |
| G11        | VCC             |
| G12        | VCCIB1          |

| FG484      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| A1         | GND             |
| A2         | GND             |
| A3         | VCCIB0          |
| A4         | NC              |
| A5         | NC              |
| A6         | IO15RSB0        |
| A7         | IO18RSB0        |
| A8         | NC              |
| A9         | NC              |
| A10        | IO23RSB0        |
| A11        | IO29RSB0        |
| A12        | IO35RSB0        |
| A13        | IO36RSB0        |
| A14        | NC              |
| A15        | NC              |
| A16        | IO50RSB0        |
| A17        | IO51RSB0        |
| A18        | NC              |
| A19        | NC              |
| A20        | VCCIB0          |
| A21        | GND             |
| A22        | GND             |
| B1         | GND             |
| B2         | VCCIB3          |
| B3         | NC              |
| B4         | NC              |
| B5         | NC              |
| B6         | NC              |
| B7         | NC              |
| B8         | NC              |
| B9         | NC              |
| B10        | NC              |
| B11        | NC              |
| B12        | NC              |
| B13        | NC              |
| B14        | NC              |

| FG484      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| B15        | NC              |
| B16        | NC              |
| B17        | NC              |
| B18        | NC              |
| B19        | NC              |
| B20        | NC              |
| B21        | VCCIB1          |
| B22        | GND             |
| C1         | VCCIB3          |
| C2         | NC              |
| C3         | NC              |
| C4         | NC              |
| C5         | GND             |
| C6         | NC              |
| C7         | NC              |
| C8         | VCC             |
| C9         | VCC             |
| C10        | NC              |
| C11        | NC              |
| C12        | NC              |
| C13        | NC              |
| C14        | VCC             |
| C15        | VCC             |
| C16        | NC              |
| C17        | NC              |
| C18        | GND             |
| C19        | NC              |
| C20        | NC              |
| C21        | NC              |
| C22        | VCCIB1          |
| D1         | NC              |
| D2         | NC              |
| D3         | NC              |
| D4         | GND             |
| D5         | GAA0/IO00RSB0   |
| D6         | GAA1/IO01RSB0   |

| FG484      |                 |
|------------|-----------------|
| Pin Number | A3P400 Function |
| D7         | GAB0/IO02RSB0   |
| D8         | IO16RSB0        |
| D9         | IO17RSB0        |
| D10        | IO22RSB0        |
| D11        | IO28RSB0        |
| D12        | IO34RSB0        |
| D13        | IO37RSB0        |
| D14        | IO41RSB0        |
| D15        | IO43RSB0        |
| D16        | GBB1/IO57RSB0   |
| D17        | GBA0/IO58RSB0   |
| D18        | GBA1/IO59RSB0   |
| D19        | GND             |
| D20        | NC              |
| D21        | NC              |
| D22        | NC              |
| E1         | NC              |
| E2         | NC              |
| E3         | GND             |
| E4         | GAB2/IO154UDB3  |
| E5         | GAA2/IO155UDB3  |
| E6         | IO12RSB0        |
| E7         | GAB1/IO03RSB0   |
| E8         | IO13RSB0        |
| E9         | IO14RSB0        |
| E10        | IO21RSB0        |
| E11        | IO27RSB0        |
| E12        | IO32RSB0        |
| E13        | IO38RSB0        |
| E14        | IO42RSB0        |
| E15        | GBC1/IO55RSB0   |
| E16        | GBB0/IO56RSB0   |
| E17        | IO44RSB0        |
| E18        | GBA2/IO60PDB1   |
| E19        | IO60NDB1        |
| E20        | GND             |

| FG484      |                  |
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| Pin Number | A3P1000 Function |
| Y15        | VCC              |
| Y16        | NC               |
| Y17        | NC               |
| Y18        | GND              |
| Y19        | NC               |
| Y20        | NC               |
| Y21        | NC               |
| Y22        | VCCIB1           |
| AA1        | GND              |
| AA2        | VCCIB3           |
| AA3        | NC               |
| AA4        | IO181RSB2        |
| AA5        | IO178RSB2        |
| AA6        | IO175RSB2        |
| AA7        | IO169RSB2        |
| AA8        | IO166RSB2        |
| AA9        | IO160RSB2        |
| AA10       | IO152RSB2        |
| AA11       | IO146RSB2        |
| AA12       | IO139RSB2        |
| AA13       | IO133RSB2        |
| AA14       | NC               |
| AA15       | NC               |
| AA16       | IO122RSB2        |
| AA17       | IO119RSB2        |
| AA18       | IO117RSB2        |
| AA19       | NC               |
| AA20       | NC               |
| AA21       | VCCIB1           |
| AA22       | GND              |
| AB1        | GND              |
| AB2        | GND              |
| AB3        | VCCIB2           |
| AB4        | IO180RSB2        |
| AB5        | IO176RSB2        |
| AB6        | IO173RSB2        |

| FG484      |                  |
|------------|------------------|
| Pin Number | A3P1000 Function |
| AB7        | IO167RSB2        |
| AB8        | IO162RSB2        |
| AB9        | IO156RSB2        |
| AB10       | IO150RSB2        |
| AB11       | IO145RSB2        |
| AB12       | IO144RSB2        |
| AB13       | IO132RSB2        |
| AB14       | IO127RSB2        |
| AB15       | IO126RSB2        |
| AB16       | IO123RSB2        |
| AB17       | IO121RSB2        |
| AB18       | IO118RSB2        |
| AB19       | NC               |
| AB20       | VCCIB2           |
| AB21       | GND              |
| AB22       | GND              |

| Revision                                                                                        | Changes                                                                                                                                                                                                                                                                                           | Page   |
|-------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| <b>Revision 9 (Oct 2009)</b><br>Product Brief v1.3                                              | The CS121 package was added to table under "Features and Benefits" section, the "I/Os Per Package 1" table, Table 1 • ProASIC3 FPGAs Package Sizes Dimensions, "ProASIC3 Ordering Information", and the "Temperature Grade Offerings" table.                                                      | I – IV |
|                                                                                                 | "ProASIC3 Ordering Information" was revised to include the fact that some RoHS compliant packages are halogen-free.                                                                                                                                                                               | IV     |
|                                                                                                 | Packaging v1.5<br>The "CS121 – Bottom View" figure and pin table for A3P060 are new.                                                                                                                                                                                                              | 4-15   |
| <b>Revision 8 (Aug 2009)</b><br>Product Brief v1.2<br><br>DC and Switching Characteristics v1.4 | All references to M7 devices (CoreMP7) and speed grade –F were removed from this document.                                                                                                                                                                                                        | N/A    |
|                                                                                                 | Table 1-1 I/O Standards supported is new.                                                                                                                                                                                                                                                         | 1-7    |
|                                                                                                 | The I/Os with Advanced I/O Standards section was revised to add definitions of hot-swap and cold-sparing.                                                                                                                                                                                         | 1-7    |
|                                                                                                 | 3.3 V LVCMOS and 1.2 V LVCMOS Wide Range support was added to the datasheet. This affects all tables that contained 3.3 V LVCMOS and 1.2 V LVCMOS data.                                                                                                                                           | N/A    |
|                                                                                                 | $I_{IL}$ and $I_{IH}$ input leakage current information was added to all "Minimum and Maximum DC Input and Output Levels" tables.                                                                                                                                                                 | N/A    |
|                                                                                                 | –F was removed from the datasheet. The speed grade is no longer supported.                                                                                                                                                                                                                        | N/A    |
|                                                                                                 | The notes in Table 2-2 • Recommended Operating Conditions 1 were updated.                                                                                                                                                                                                                         | 2-2    |
|                                                                                                 | Table 2-4 • Overshoot and Undershoot Limits 1 was updated.                                                                                                                                                                                                                                        | 2-3    |
|                                                                                                 | Table 2-6 • Temperature and Voltage Derating Factors for Timing Delays was updated.                                                                                                                                                                                                               | 2-6    |
|                                                                                                 | In Table 2-116 • RAM4K9, the following specifications were removed:<br>$t_{WRO}$<br>$t_{CCKH}$                                                                                                                                                                                                    | 2-96   |
|                                                                                                 | In Table 2-117 • RAM512X18, the following specifications were removed:<br>$t_{WRO}$<br>$t_{CCKH}$                                                                                                                                                                                                 | 2-97   |
|                                                                                                 | In the title of Table 2-74 • 1.8 V LVCMOS High Slew, VCCI had a typo. It was changed from 3.0 V to 1.7 V.                                                                                                                                                                                         | 2-58   |
| <b>Revision 7 (Feb 2009)</b><br>Product Brief v1.1                                              | The "Advanced I/O" section was revised to add a bullet regarding wide range power supply voltage support.                                                                                                                                                                                         | I      |
|                                                                                                 | The table under "Features and Benefits" section, was updated to include a value for typical equivalent macrocells for A3P250.                                                                                                                                                                     | I      |
|                                                                                                 | The QN48 package was added to the following tables: the table under "Features and Benefits" section, "I/Os Per Package 1" "ProASIC3 FPGAs Package Sizes Dimensions", and "Temperature Grade Offerings".<br>The number of singled-ended I/Os for QN68 was added to the "I/Os Per Package 1" table. | N/A    |
|                                                                                                 | The Wide Range I/O Support section is new.                                                                                                                                                                                                                                                        | 1-7    |
| <b>Revision 6 (Dec 2008)</b><br>Packaging v1.4                                                  | The "QN48 – Bottom View" section is new.                                                                                                                                                                                                                                                          | 4-1    |
|                                                                                                 | The "QN68" pin table for A3P030 is new.                                                                                                                                                                                                                                                           | 4-5    |